

Data sheet

CPU 315SN (315-4NE23)

Technical data

Type	Order no.	315-4NE23
Powered by SPEED7	Туре	CPU 315SN
Features Powered by SPEED7 Work memory [RB]: 1,241,4,096 Integrated: Ethernet CP343-Lean Interface [R345]: active Ethernet CP343-Lean Interface [R345]: active Ethernet CP343 & PG(OP-communication Interface [R345]: Active Ethernet CP343 & PG(OP-communication Interface [R345]: MPI Interface [R345]: PROFIBUS master/slave, PIP: ASCII, STXETX, 3964(R), USS master/slave, PIP: ASCII, STXETX, 3964(R), USS master/slave, PIP: ASCII, STXETS, 3964(R), USS master/slave, PIP: ASCII, Interface [R448] PCGCP-communication modules PIP Balton and Communication modules PIP Balton and Communication modules PIP Interputs Interputs Interface [R456] Interputs Interface [R456] Interface [General information	
Work memory [KB]: 1,0244.096 Integrated: Ethernet CP343-Lean Interface [RJ45]: Ethernet PG/OP communication Interface [RJ45]: Ethernet PG/OP communication Interface [RJ45]: Audit per Interface [RJ45]: MPI Interface [RJ	Note	-
Technical data power supply Power supply (rated value) Power supply (permitted range) DC 24 V Power supply (permitted range) DC 20.428.8 V Reverse polarity protection yes Current consumption (no-load operation) 270 mA Current consumption (rated value) 1 A Inrush current 5 A Pt 0.5 A?s Max. current drain at backplane bus 2.5 A Max. current drain load supply - Power loss 8.5 W Load and working memory Load memory, integrated 4 MB Load memory, maximum 4 MB Work memory, maximum 4 MB Memory divided in 50% program / 50% data Memory divided in 50% program / 50% data yes Memory card slot SD/MMC-Card with max. 2 GB Hardware configuration Racks, max. 4 Modules per rack, max. 8 in multiple-, 32 in a single-rack configuration Number of IDP master via CP 4 Operable function modules Operable communication modules PIP 8 Operable communication modules LAN 8 Status information, alarms, diagnostics Status display yes Interrupts	Features	Work memory [KB]: 1.0244.096 Integrated: Ethernet CP343-Lean Interface [RJ45]: Ethernet PG/OP communication Interface [RJ45]: active Ethernet CP343 & PG/OP-communication Interface [RS485]: MPI Interface [RS485]: MPI Interface [RS485]: PROFIBUS master/slave, PtP: ASCII, STX/ETX, 3964(R), USS master, Modbus master/slave SD/MMC card slot with locking, up to 32 modules stackable,
Power supply (rated value) Power supply (permitted range) DC 20.428.8 V Reverse polarity protection yes Current consumption (no-load operation) 270 mA Current consumption (rated value) 1 A Inrush current 5 A Pt 0.5 APs Max. current drain at backplane bus 8.5 W Load and working memory Load memory, integrated 4 MB Load memory, integrated 4 MB Work memory, integrated 1 MB Work memory, divided in 50% program / 50% data Memory divided in 50% program / 50% data yes Memory card slot Hardware configuration Racks, max. 4 Modules per rack, max. Number of integrated DP master Number of integrated DP master Number of integrated DP master 1 Number of integrated DP master Number of integrated DP master via CP Operable communication modules Operable communication modules PtP 8 Operable communication modules LAN 8 Status information, alarms, diagnostics Status display Interrupts Interrupts DC 24 V De A DC 24 V DC 25 A DC 26 V DC	SPEED-Bus	-
Power supply (permitted range) Reverse polarity protection Qurrent consumption (no-load operation) 270 mA Current consumption (rated value) 1 A Inrush current 5 A Pt 0.5 A*s Max. current drain at backplane bus 2.5 A Max. current drain load supply - Power loss 8.5 W Load and working memory Load memory, integrated 4 MB Load memory, integrated 1 MB Work memory, integrated 1 MB Work memory, divided in 50% program / 50% data Wesh Memory divided in 50% program / 50% data yes Memory card slot Hardware configuration Racks, max. 4 Modules per rack, max. Number of integrated DP master 1 Number of DP master via CP Operable function modules Operable communication modules PtP 8 Operable communication modules LAN 8 Status information, alarms, diagnostics Status display Interrupts Interrupts Interrupts DC 20.428.8 V BC 270 mA A A A B C 270 mA A A B C 270 mA A A B C 270 mA A A MB	Technical data power supply	
Reverse polarity protection yes Current consumption (no-load operation) 270 mA Current consumption (rated value) 1 A Inrush current 5 A Pt 0.5 A²s Max. current drain at backplane bus 2.5 A Max. current drain load supply - Power loss 8.5 W Load and working memory Load memory, integrated 4 MB Work memory, maximum 4 MB Work memory, maximal 4 MB Work memory, divided in 50% program / 50% data yes Memory card slot Hardware configuration Racks, max. 4 Modules per rack, max. 8 in multiple-, 32 in a single-rack configuration Number of Integrated DP master 1 Number of DP master via CP 4 Operable function modules AN 8 Status information, alarms, diagnostics Status display yes Interrupts	Power supply (rated value)	DC 24 V
Current consumption (no-load operation) Current consumption (rated value) 1 A Inrush current 5 A Pt 0.5 A ² s Max. current drain at backplane bus 2.5 A Max. current drain load supply - Power loss 8.5 W Load and working memory Load memory, integrated 4 MB Load memory, maximum 4 MB Work memory, integrated 1 MB Work memory, maximal 4 MB Memory divided in 50% program / 50% data yes Memory card slot SD/MMC-Card with max. 2 GB Hardware configuration Racks, max. 4 Modules per rack, max. 8 in multiple-, 32 in a single-rack configuration Number of DP master via CP 4 Operable function modules 8 Cperable communication modules PtP 8 Cperable communication modules LAN 8 Status information, alarms, diagnostics Status display yes Interrupts	Power supply (permitted range)	DC 20.428.8 V
Current consumption (rated value) 1 A Inrush current 5 A Pt 0.5 A²s Max. current drain at backplane bus 2.5 A Max. current drain load supply - Power loss 8.5 W Load and working memory Load memory, integrated 4 MB Load memory, maximum 4 MB Work memory, integrated 1 MB Work memory, mitegrated 1 MB Work memory divided in 50% program / 50% data yes Memory divided in 50% program / 50% data yes Memory card slot SD/MMC-Card with max. 2 GB Hardware configuration Racks, max. 4 Modules per rack, max. 8 in multiple-, 32 in a single-rack configuration Number of Integrated DP master 1 Number of DP master via CP 4 Operable function modules CPP 8 Operable communication modules PtP 8 Operable communication modules LAN 8 Status information, alarms, diagnostics Status display yes Interrupts	Reverse polarity protection	yes
Inrush current 5 A Pt 0.5 A2s Max. current drain at backplane bus 2.5 A Max. current drain load supply - Power loss 8.5 W Load and working memory Load memory, integrated 4 MB Load memory, maximum 4 MB Work memory, integrated 1 MB Work memory divided in 50% program / 50% data yes Memory divided in 50% program / 50% data yes Memory card slot SD/MMC-Card with max. 2 GB Hardware configuration Racks, max. 4 Modules per rack, max. 8 in multiple-, 32 in a single-rack configuration Number of integrated DP master 1 Number of DP master via CP 4 Operable function modules PtP 8 Operable communication modules PtP 8 Status information, alarms, diagnostics Status display yes Interrupts 1	Current consumption (no-load operation)	270 mA
Pit 0.5 A2s Max. current drain at backplane bus 2.5 A Max. current drain load supply - Power loss 8.5 W Load and working memory Load memory, integrated 4 MB Load memory, maximum 4 MB Work memory, integrated 1 MB Work memory, integrated 4 MB Memory divided in 50% program / 50% data yes Memory card slot SD/MMC-Card with max. 2 GB Hardware configuration Racks, max. 4 Modules per rack, max. 8 in multiple-, 32 in a single-rack configuration Number of integrated DP master 1 Number of DP master via CP 4 Operable function modules PtP 8 Operable communication modules PtP 8 Status information, alarms, diagnostics Status display yes Interrupts no	Current consumption (rated value)	1 A
Max. current drain at backplane bus Max. current drain load supply	Inrush current	5 A
Max. current drain load supply - Power loss - 8.5 W Load and working memory Load memory, integrated 4 MB Load memory, maximum 4 MB Work memory, integrated 1 MB Work memory, maximal 4 MB Memory divided in 50% program / 50% data yes Memory card slot SD/MMC-Card with max. 2 GB Hardware configuration Racks, max. 4 Modules per rack, max. 8 in multiple-, 32 in a single-rack configuration Number of integrated DP master 1 Number of DP master via CP 4 Operable function modules PtP 8 Operable communication modules LAN 8 Status information, alarms, diagnostics Status display yes Interrupts no	2 _t	0.5 A²s
Power loss Load and working memory Load memory, integrated 4 MB Load memory, maximum 4 MB Work memory, integrated 1 MB Work memory, maximal 4 MB Memory divided in 50% program / 50% data yes Memory card slot SD/MMC-Card with max. 2 GB Hardware configuration Racks, max. 4 Modules per rack, max. 8 in multiple-, 32 in a single-rack configuration Number of integrated DP master 1 Number of DP master via CP 4 Operable function modules Operable communication modules PtP 8 Status information, alarms, diagnostics Status display yes Interrupts	Max. current drain at backplane bus	2.5 A
Load and working memory Load memory, integrated 4 MB Load memory, maximum 4 MB Work memory, integrated 1 MB Work memory, maximal 4 MB Memory divided in 50% program / 50% data yes Memory card slot SD/MMC-Card with max. 2 GB Hardware configuration Racks, max. 4 Modules per rack, max. 8 in multiple-, 32 in a single-rack configuration Number of integrated DP master 1 Number of DP master via CP 4 Operable function modules 8 Operable communication modules PtP 8 Operable communication modules LAN 8 Status information, alarms, diagnostics Status display yes Interrupts no	Max. current drain load supply	
Load memory, integrated 4 MB Load memory, maximum 4 MB Work memory, integrated 1 MB Work memory, maximal 4 MB Memory divided in 50% program / 50% data yes Memory card slot SD/MMC-Card with max. 2 GB Hardware configuration Racks, max. 4 Modules per rack, max. 8 in multiple-, 32 in a single-rack configuration Number of integrated DP master 1 Number of DP master via CP 4 Operable function modules 8 Operable communication modules PtP 8 Operable communication modules LAN 8 Status information, alarms, diagnostics Status display yes Interrupts no	Power loss	8.5 W
Load memory, maximum 4 MB Work memory, integrated 1 MB Work memory, maximal 4 MB Memory divided in 50% program / 50% data yes Memory card slot SD/MMC-Card with max. 2 GB Hardware configuration Racks, max. 4 Modules per rack, max. Modules per rack, max. 8 in multiple-, 32 in a single-rack configuration Number of integrated DP master 1 Number of DP master via CP 4 Operable function modules 8 Operable communication modules PtP 8 Operable communication modules LAN 8 Status information, alarms, diagnostics Status display yes Interrupts no	Load and working memory	
Work memory, integrated 1 MB Work memory, maximal 4 MB Memory divided in 50% program / 50% data yes Memory card slot SD/MMC-Card with max. 2 GB Hardware configuration Racks, max. 4 Modules per rack, max. 8 in multiple-, 32 in a single-rack configuration Number of integrated DP master 1 Number of DP master via CP 4 Operable function modules 8 Operable communication modules PtP 8 Status information, alarms, diagnostics Status display yes Interrupts no	Load memory, integrated	4 MB
Work memory, maximal Memory divided in 50% program / 50% data yes Memory card slot SD/MMC-Card with max. 2 GB Hardware configuration Racks, max. 4 Modules per rack, max. 8 in multiple-, 32 in a single-rack configuration Number of integrated DP master 1 Number of DP master via CP 4 Operable function modules 8 Operable communication modules PtP 8 Operable communication modules LAN 8 Status information, alarms, diagnostics Status display Interrupts no	Load memory, maximum	4 MB
Memory divided in 50% program / 50% data Memory card slot Bol/MMC-Card with max. 2 GB Hardware configuration Racks, max. 4 Modules per rack, max. 8 in multiple-, 32 in a single-rack configuration Number of integrated DP master 1 Number of DP master via CP 4 Operable function modules 8 Operable communication modules PtP 8 Operable communication modules LAN 8 Status information, alarms, diagnostics Status display Interrupts no	Work memory, integrated	1 MB
Memory card slot Hardware configuration Racks, max. 4 Modules per rack, max. 8 in multiple-, 32 in a single-rack configuration Number of integrated DP master 1 Number of DP master via CP 4 Operable function modules 8 Operable communication modules PtP 8 Status information, alarms, diagnostics Status display Interrupts SD/MMC-Card with max. 2 GB 8 4 4 4 8 8 In multiple-, 32 in a single-rack configuration 8 8 4 8 8 8 Status display 9 9 9 1 1 1 1 1 1 1 1 1 1	Work memory, maximal	4 MB
Hardware configuration Racks, max. 4 Modules per rack, max. 8 in multiple-, 32 in a single-rack configuration Number of integrated DP master 1 Number of DP master via CP 4 Operable function modules 8 Operable communication modules PtP 8 Operable communication modules LAN 8 Status information, alarms, diagnostics Status display yes Interrupts no	Memory divided in 50% program / 50% data	yes
Racks, max. Modules per rack, max. 8 in multiple-, 32 in a single-rack configuration Number of integrated DP master 1 Number of DP master via CP 4 Operable function modules 8 Operable communication modules PtP 8 Operable communication modules LAN Status information, alarms, diagnostics Status display yes Interrupts no	Memory card slot	SD/MMC-Card with max. 2 GB
Modules per rack, max. 8 in multiple-, 32 in a single-rack configuration Number of integrated DP master 1 Number of DP master via CP 4 Operable function modules 8 Operable communication modules PtP 8 Operable communication modules LAN 8 Status information, alarms, diagnostics Status display yes Interrupts no	Hardware configuration	
Number of integrated DP master 1 Number of DP master via CP 4 Operable function modules 8 Operable communication modules PtP 8 Operable communication modules LAN 8 Status information, alarms, diagnostics Status display yes Interrupts no	Racks, max.	4
Number of DP master via CP 4 Operable function modules 8 Operable communication modules PtP 8 Operable communication modules LAN 8 Status information, alarms, diagnostics Status display yes Interrupts no	Modules per rack, max.	8 in multiple-, 32 in a single-rack configuration
Operable function modules 8 Operable communication modules PtP 8 Operable communication modules LAN 8 Status information, alarms, diagnostics Status display yes Interrupts no	Number of integrated DP master	1
Operable communication modules PtP 8 Operable communication modules LAN 8 Status information, alarms, diagnostics Status display yes Interrupts no	Number of DP master via CP	4
Operable communication modules LAN 8 Status information, alarms, diagnostics Status display yes Interrupts no	Operable function modules	8
Status information, alarms, diagnostics Status display yes Interrupts no	Operable communication modules PtP	8
Status display yes Interrupts no	Operable communication modules LAN	8
Status display yes Interrupts no	Status information, alarms, diagnostics	
Interrupts no		yes
		•
	· · · ·	

YASKAWA

	IASKAWA
Diagnostic interrupt	no
Diagnostic functions	no
Diagnostics information read-out	possible
Supply voltage display	green LED
Group error display	red SF LED
Channel error display	none
Command processing times	
Bit instructions, min.	0.01 μs
Word instruction, min.	0.01 µs
Double integer arithmetic, min.	0.01 µs
Floating-point arithmetic, min.	0.06 μs
Timers/Counters and their retentive character	istics
Number of S7 counters	512
S7 counter remanence	adjustable 0 up to 512
S7 counter remanence adjustable	C0 C7
Number of S7 times	512
S7 times remanence	adjustable 0 up to 512
S7 times remanence adjustable	not retentive
Data range and retentive characteristic	
Number of flags	8192 Byte
Bit memories retentive characteristic adjustable	adjustable 0 up to 8192
Bit memories retentive characteristic preset	MB0 MB15
Number of data blocks	4095
Max. data blocks size	64 KB
Number range DBs	1 4095
Max. local data size per execution level	1024 Byte
Max. local data size per block	1024 Byte
Blocks	
Number of OBs	23
Maximum OB size	64 KB
Total number DBs, FBs, FCs	-
Number of FBs	2048
Maximum FB size	64 KB
Number range FBs	0 2047
Number of FCs	2048
Maximum FC size	64 KB
Number range FCs	0 2047
Maximum nesting depth per priority class	8
Maximum nesting depth additional within an error OB	4
Time	
Real-time clock buffered	yes
Clock buffered period (min.)	6 w
Type of buffering	Vanadium Rechargeable Lithium Battery
Load time for 50% buffering period	20 h
Load time for 100% buffering period	48 h
Accuracy (max. deviation per day)	10 s
Number of operating hours counter	8



Clock synchronization	yes
Synchronization via MPI	Master/Slave
Synchronization via Ethernet (NTP)	Slave
Address areas (I/O)	
Input I/O address area	8192 Byte
Output I/O address area	8192 Byte
Process image adjustable	yes
Input process image preset	256 Byte
Output process image preset	256 Byte
Input process image maximal	2048 Byte
Output process image maximal	2048 Byte
Digital inputs	65536
Digital outputs	65536
Digital inputs central	1024
Digital outputs central	1024
Integrated digital inputs	-
Integrated digital outputs	-
Analog inputs	4096
Analog outputs	4096
Analog inputs, central	256
Analog outputs, central	256
Integrated analog inputs	-
Integrated analog outputs	-
Communication functions	
PG/OP channel	yes
Global data communication	yes
Number of GD circuits, max.	8
Size of GD packets, max.	54 Byte
S7 basic communication	yes
S7 basic communication, user data per job	76 Byte
S7 communication	yes
S7 communication as server	yes
S7 communication as client	-
S7 communication, user data per job	160 Byte
Number of connections, max.	32
Functionality Sub-D interfaces	
Туре	X2
Type of interface	RS485
Connector	Sub-D, 9-pin, female
Electrically isolated	yes
MPI	yes
MP²l (MPI/RS232)	-
DP master	-
DP slave	-
Point-to-point interface	-
5V DC Power supply	max. 90mA, isolated
24V DC Power supply	max. 100mA, non-isolated

YASKAWA

Туре	X3
Type of interface	RS485
Connector	Sub-D, 9-pin, female
Electrically isolated	yes
MPI	-
MP²I (MPI/RS232)	-
DP master	yes
DP slave	yes
Point-to-point interface	yes
5V DC Power supply	max. 90mA, isolated
24V DC Power supply	max. 100mA, non-isolated
Functionality MPI	
Number of connections, max.	32
PG/OP channel	yes
Routing	yes
Global data communication	yes
S7 basic communication	yes
S7 communication	yes
S7 communication as server	yes
S7 communication as client	-
Transmission speed, min.	19.2 kbit/s
Transmission speed, max.	12 Mbit/s
Functionality PROFIBUS master	
Number of connections, max.	32
PG/OP channel	yes
Routing	yes
S7 basic communication	yes
S7 communication	yes
S7 communication as server	yes
S7 communication as client	-
Activation/deactivation of DP slaves	yes
Direct data exchange (slave-to-slave communication)	-
DPV1	yes
Transmission speed, min.	9.6 kbit/s
Transmission speed, max.	12 Mbit/s
Number of DP slaves, max.	124
Address range inputs, max.	8 KB
Address range outputs, max.	8 KB
User data inputs per slave, max.	244 Byte
User data outputs per slave, max.	244 Byte
Functionality PROFIBUS slave	
Number of connections, max.	32
PG/OP channel	yes
Routing	yes
S7 communication	yes
S7 communication as server	yes
S7 communication as client	-
Direct data exchange (slave-to-slave communication)	-

YASKAWA

DPV1	yes
Transmission speed, min.	9.6 kbit/s
Transmission speed, max.	12 Mbit/s
Automatic detection of transmission speed	-
Transfer memory inputs, max.	244 Byte
Transfer memory outputs, max.	244 Byte
Address areas, max.	32
User data per address area, max.	32 Byte
Functionality RJ45 interfaces	
Туре	X5
Type of interface	Ethernet 10/100 MBit
Connector	RJ45
Electrically isolated	yes
PG/OP channel	yes
Number of connections, max.	4
Productive connections	-
Fieldbus	-
Туре	X8
Type of interface	Ethernet 10/100 MBit
Connector	RJ45
Electrically isolated	yes
PG/OP channel	yes
Number of connections, max.	32
Productive connections	yes
Fieldbus	-
Point-to-point communication	
PtP communication	yes
Interface isolated	yes
RS232 interface	-
RS422 interface	-
RS485 interface	yes
Connector	Sub-D, 9-pin, female
Transmission speed, min.	150 bit/s
Transmission speed, max.	115.5 kbit/s
Cable length, max.	500 m
Point-to-point protocol	
ASCII protocol	yes
STX/ETX protocol	yes
3964(R) protocol	yes
RK512 protocol	-
USS master protocol	yes
Modbus master protocol	yes
Modbus slave protocol	-
Special protocols	-
Ethernet communication CP	
Number of configurable connections, max.	8
Number of productive connections by Siemens NetPro, max.	8



S7 connections	BSEND, BRCV, GET, PUT, Connection of active and passive data handling
User data per S7 connection, max.	32 KB
TCP-connections	SEND, RECEIVE, FETCH PASSIV, WRITE PASSIV, Connection of active and passive data handling
User data per TCP connection, max.	64 KB
ISO-connections	SEND, RECEIVE, FETCH PASSIV, WRITE PASSIV, Connection of active and passive data handling
User data per ISO connection, max.	8 KB
ISO on TCP connections (RFC 1006)	SEND, RECEIVE, FETCH PASSIV, WRITE PASSIV, Connection of active and passive data handling
User data per ISO on TCP connection, max.	32 KB
UDP-connections	SEND and RECEIVE
User data per UDP connection, max.	2 KB
UDP-multicast-connections	SEND and RECEIVE (max. 8 Multicast groups)
UDP-broadcast-connections	SEND
Ethernet open communication	
Number of connections, max.	8
ISO on TCP connections (RFC 1006)	TSEND, TRCV, TCON, TDISCON
User data per ISO on TCP connection, max.	8 KB
TCP-Connections native	TSEND, TRCV, TCON, TDISCON
User data per native TCP connection, max.	8 KB
User data per ad hoc TCP connection, max.	1460 Byte
UDP-connections	TUSEND, TURCV
User data per UDP connection, max.	1472 Byte
Management & diagnosis	
Protocols	-
Web based diagnosis	-
NCM diagnosis	-
Housing	
Material	PPE
Mounting	Rail System 300
Mechanical data	
Dimensions (WxHxD)	80 mm x 125 mm x 120 mm
Net weight	430 g
Weight including accessories	-
Gross weight	-
Environmental conditions	
Operating temperature	0 °C to 60 °C
Storage temperature	-25 °C to 70 °C
Certifications	
UL certification	yes
KC certification	yes